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N-Channel PowerTrench[®] SyncFETTM 30 V, 42 A, 4 m Ω

Features

- Max $r_{DS(on)}$ = 4.0 m Ω at V_{GS} = 10 V, I_D = 18 A
- Max $r_{DS(on)}$ = 5.2 m Ω at V_{GS} = 4.5 V, I_D = 14 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFETTM Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

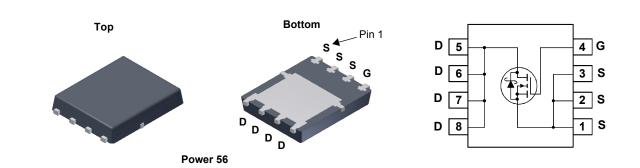


General Description

The FDMS0310S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Desktop



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{DSt}	Drain to Source Transient Voltage (t _{Transient} < 100 ns)			33	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		42		
	-Continuous (Silicon limited)	T _C = 25 °C		83		
D	-Continuous	T _A = 25 °C	(Note 1a)	19	Α	
	-Pulsed			90		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	60	mJ	
P _D	Power Dissipation	T _C = 25 °C		46	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.7	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a	50	C/W

Package Marking and Ordering Information

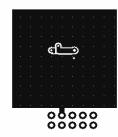
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS0310S	FDMS0310S	Power 56	13 "	12 mm	3000 units

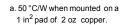
January 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, referenced to 25 °C		18		mV/°C	
DSS	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA	
I _{GSS}	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C	
0	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18 A		3.2	4.0	mΩ	
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		4.3	5.2		
20(01)		V _{GS} = 10 V, I _D = 18 A, T _J = 125 °C		4.1	5.2	1	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 18 A$		97		S	
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		735 90	975 135	pF pF	
R _g	Gate Resistance			1.1	2.2	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			12	21	ns	
t _r	Rise Time	V _{DD} = 15 V, I _D = 18 A,		5	10	ns	
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		28	44	ns	
t _f	Fall Time			4	10	ns	
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		33	46	nC	
Q _q	Total Gate Charge	V_{GS} = 0 V to 4.5 V V_{DD} = 15 V,		15	22	nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 18 A		6.5		nC	
Q _{gd}	Gate to Drain "Miller" Charge	1 †		4.0		nC	
Drain-Sou	urce Diode Characteristics						
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.48	0.7	v	
V _{SD}		$V_{GS} = 0 V, I_S = 18 A$ (Note 2)		0.80	1.2	v	
				20	40		
t _{rr}	Reverse Recovery Time	- I _F = 18 A, di/dt = 300 A/μs		26	42	ns	

Notes:

1. $R_{\theta,JA}$ is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.





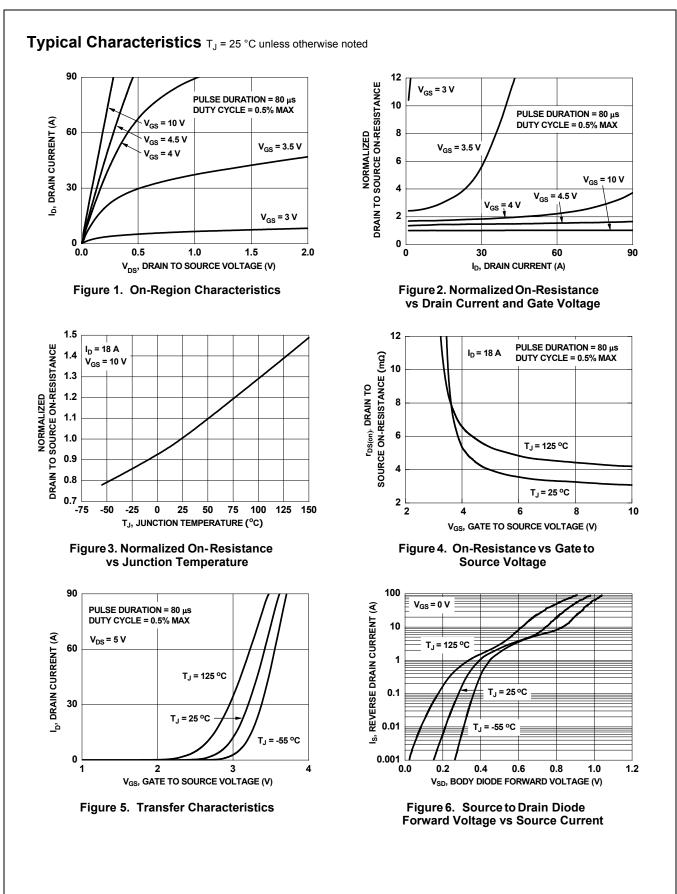
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

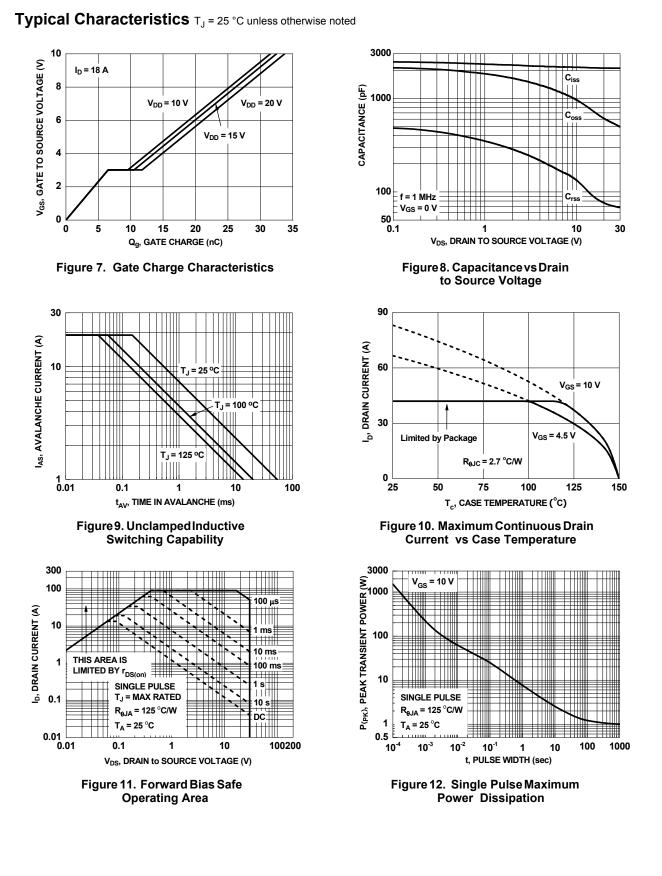


2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 60 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 11 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 16 A. 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

FDMS0310S N-Channel PowerTrench[®] SyncFETTM

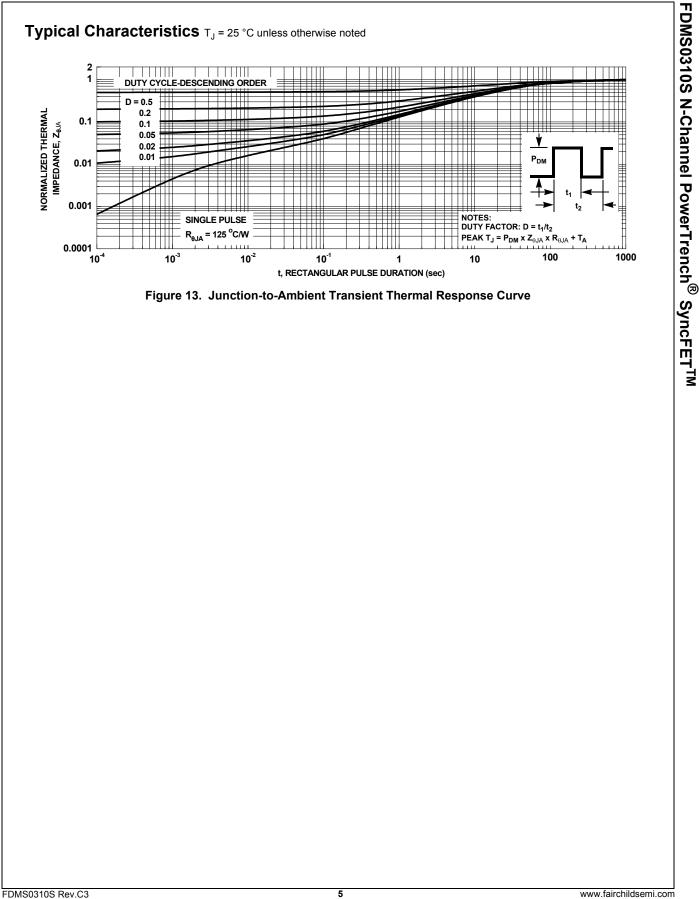
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Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS0310S.

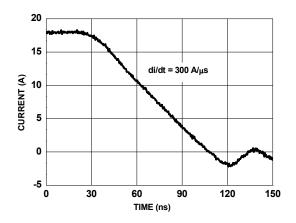


Figure 14. FDMS0310S SyncFET[™] body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

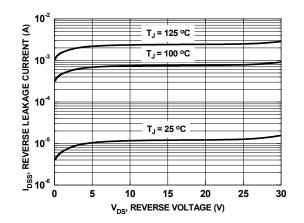


Figure 15. SyncFETTM body diode reverses leakage versus drain-source voltage



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